# SUM90140E



**Vishay Siliconix** 

# N-Channel 200 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) MAX.	I <sub>D</sub> (A)	Q <sub>g</sub> (TYP.)			
200	0.017 at $V_{GS}$ = 10 V	90	64 nC			
200	0.018 at $V_{GS}$ = 7.5 V	88	04 NC			



#### **Ordering Information:**

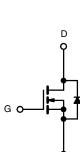
SUM90140E-GE3 (lead (Pb)-free and halogen-free)

### **FEATURES**

- ThunderFET<sup>®</sup> power MOSFET
- Maximum 175 °C junction temperature
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Power supplies:
  - Uninterruptible power supplies
  - AC/DC switch-mode power supplies
  - Lighting
- Synchronous rectification
- DC/DC converter
- Motor drive switch
- DC/AC inverter
- Solar micro inverter
- Class D audio amplifier



**RoHS** COMPLIANT

HALOGEN

FREE

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V <sub>DS</sub>	200	V			
Gate-Source Voltage	V <sub>GS</sub>	± 20	V			
Continuous Drain Current (T, = 150 °C)	T <sub>C</sub> = 25 °C	1	90	٨		
Continuous Drain Current $(1j = 150 \text{ C})$	T <sub>C</sub> = 70 °C	I <sub>D</sub>	75			
Pulsed Drain Current (t = 100 µs)		I <sub>DM</sub>	240	A		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	60			
Single Avalanche Energy <sup>a</sup>		E <sub>AS</sub>	180	mJ		
	T <sub>C</sub> = 25 °C	Р	375 <sup>b</sup>	W		
Maximum Power Dissipation <sup>a</sup>	T <sub>C</sub> = 125 °C	- P <sub>D</sub>	125 <sup>b</sup>	vv		
Operating Junction and Storage Temperature R	ange	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C		

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-Ambient (PCB Mount) <sup>c</sup>	R <sub>thJA</sub>	40	°C/W		
Junction-to-Case (Drain)	R <sub>thJC</sub>	0.4			

#### Notes

- a. Duty cycle  $\leq 1$  %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR4 material).

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS}=0~V,~I_D=250~\mu A$	200	-	-	v	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},\ I_D=250\ \mu A$	2	-	4	v	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ± 20 V	-	-	± 250	nA	
		$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}{=}200$ V, $V_{GS}{=}0$ V, $T_{J}{=}125$ $^{\circ}C$	-	-	150	μΑ	
		$V_{DS}$ = 200 V, $V_{GS}$ = 0 V, $T_J$ = 175 $^\circ C$	-	-	5	mA	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq 10~V,~V_{GS} = 10~V$	90	-	-	А	
Drain-Source On-State Resistance a	D	$V_{GS}$ = 10 V, $I_D$ = 30 A	-	0.0138	0.0170	0	
Drain-Source On-State Resistance "	R <sub>DS(on)</sub>	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	-	0.0141	0.0180	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	-	75	-	S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>		-	4132	-	pF	
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V, f = 1 MHz	-	246	-		
Reverse Transfer Capacitance	C <sub>rss</sub>		-	21	-		
Total Gate Charge <sup>c</sup>	Qg		-	64	96	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS}$ = 100 V, $V_{GS}$ = 10 V, $I_{D}$ = 60 A	-	16.7	-		
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>		-	16.9	-		
Gate Resistance	Rg	f = 1 MHz	1.5	3	5	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>		-	13	26		
Rise Time <sup>c</sup>	tr	$V_{DD}$ = 100 V, $R_L$ = 1.66 $\Omega$	-	112	200	- ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 60$ A, $V_{GEN} = 10$ V, $R_g = 1$ $\Omega$	-	35	70		
Fall Time <sup>c</sup>	t <sub>f</sub>		-	80	150		
Drain-Source Body Diode Ratings an	nd Characteri	stics <sup>b</sup> (T <sub>C</sub> = 25 °C)					
Pulsed Current (t = 100 µs)	I <sub>SM</sub>		-	-	240	А	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_F = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.8	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>		-	160	320	ns	
Peak Reverse Recovery Charge	I <sub>RM(REC)</sub>	I <sub>F</sub> = 30 A, di/dt = 100 A/μs	-	11	20	А	
Reverse Recovery Charge	Q <sub>rr</sub>		-	0.9	1.8	μC	

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

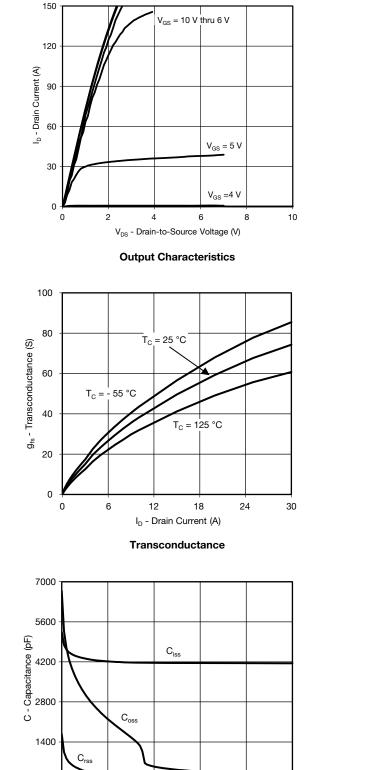
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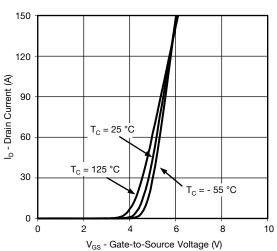


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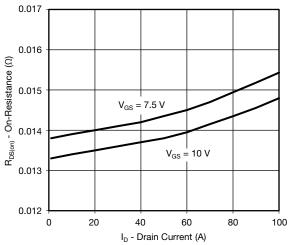
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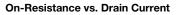
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

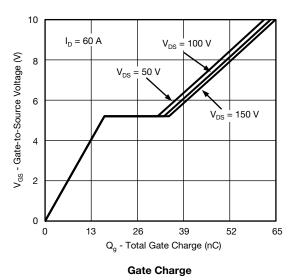




**Transfer Characteristics** 







S15-2641-Rev. A, 16-Nov-15

20

40

60

V<sub>DS</sub> - Drain-to-Source Voltage (V)

Capacitance

80

100

0

0

3

Document Number: 79035

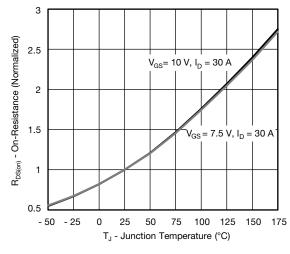
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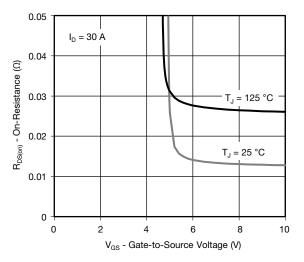


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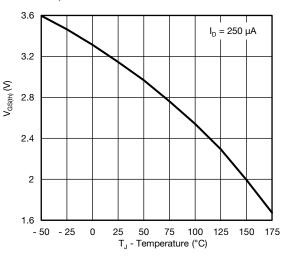
## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



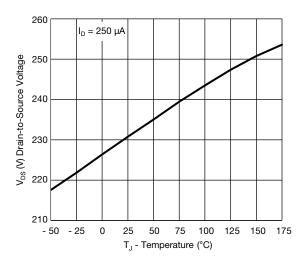
**On-Resistance vs. Junction Temperature** 



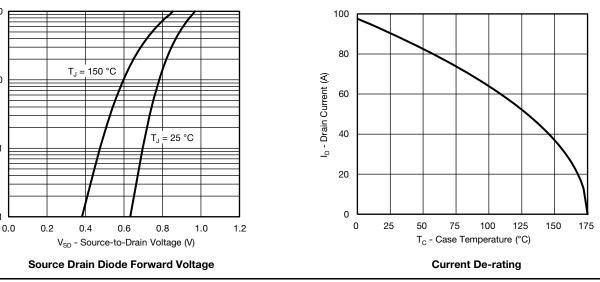
**On-Resistance vs. Gate-to-Source Voltage** 



Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



S15-2641-Rev. A, 16-Nov-15

100

10

1

0.1

I<sub>s</sub> - Source Current (A)

4

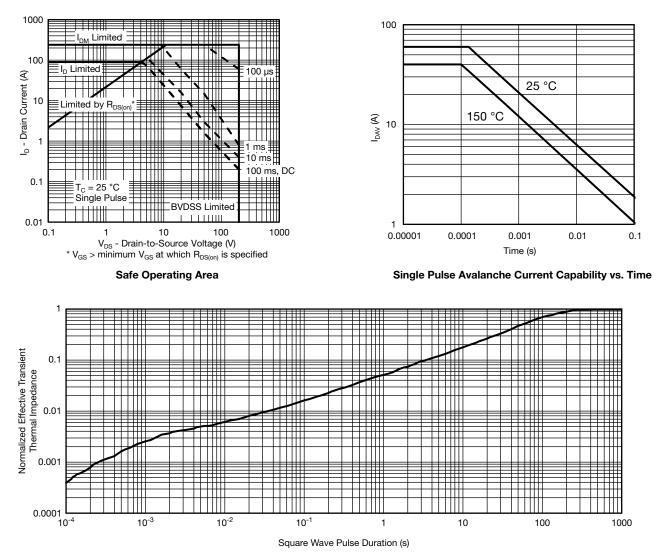
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### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

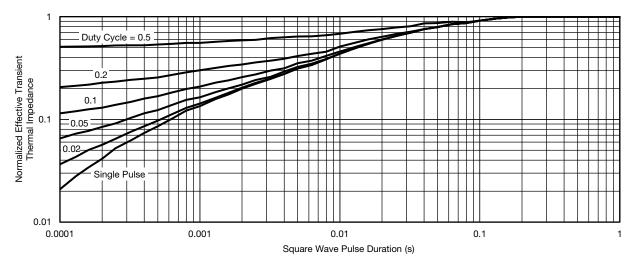


Normalized Thermal Transient Impedance, Junction-to-Ambient



## Vishay Siliconix

### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction to Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?79035">www.vishay.com/ppg?79035</a>.



**Vishay Siliconix** 

TO-263 (D<sup>2</sup>PAK): 3-LEAD









DETAIL A (ROTATED 90°)



		INCHES		MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
A		0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
D2		0.038	0.042	0.965	1.067	
D3		0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	E	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
	E2	0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100 BSC		2.54 BSC		
	К	0.045	0.055	1.143	1.397	
	L	0.575	0.625	14.605	15.875	
	L1	0.090	0.110	2.286	2.794	
L2		0.040	0.055	1.016	1.397	
	L3	0.050	0.070	1.270	1.778	
	L4	0.010 BSC 0.25		0.254	4 BSC	
	М	-	0.002	- 0.050		
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843						

#### Notes

- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 % of L1 can fall above seating plane by
- max. 8 mils.3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB.
  - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



### **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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